IBC Module

IB0xxQ120T53xx-xx

4:1 Intermediate Bus Converter Module: Up to 650W Output

Size:
2.30 x 1.45 x 0.42in
58.4 x 36.8 x 10.6mm

Features & Benefits

- Input: 36 – 60V_{DC} (38 – 55V_{DC} for IB048x)
- Output: 12.0V_{DC} at 48V_{IN}
- Output current up to 53A
- Output power: up to 650W *
- 2250V_{DC} isolation (1500V_{DC} isolation for IB048x)
- 97.9% peak efficiency
- Low profile: 0.42” height above board
- Industry standard 1/4 Brick pinout
- Sine Amplitude Converter™ (SAC™)
- Low noise 1MHz ZVS/ZCS

* For lower power applications see 300W model IB0Q120T32xx-xx

Typical Applications

- Enterprise networks
- Optical access networks
- Storage networks
- Automated test equipment

Product Description

The Intermediate Bus Converter (IBC) Module is a very efficient, low profile, isolated, fixed ratio converter for power system applications in enterprise and optical access networks.
Rated at up to 477W from 36V_{IN} and up to 650W from 50 to 60V_{IN}, the IBC conforms to an industry standard quarter-brick footprint while supplying power greatly exceeding competitive quarter-bricks. Its leading efficiency enables full load operation at 55°C with only 200LFM airflow. Its small cross section facilitates unimpeded airflow — above and below its thin body — to minimize the temperature rise of downstream components. A baseplate option is available for alternative cooling schemes.

Part Ordering Information

Product Function		Input Voltage			Package	Output Voltage (Nom.) x 10			Temperature Grade	Output Current		Enable Logic	Pin Length	Options		
I	B	0	x	x	Q	1	2	0	T	5	3	x	x	–	x	x

IB = Intermediate Bus Converter

048 = 38 – 55V_{DC}
050 = 36 – 60V_{DC}
054= 36 – 60V_{DC} *
* Operating transient to 75V_{DC}

Q = Quarter Brick Format

120 = (V_{OUT} nominal @ V_{IN} = 48V_{DC} x 10 (4:1 transfer ratio)

T = -40°C ≤ $T_{OPERATING}$ ≤ +100°C
-40°C ≤ $T_{STORAGE}$ ≤ +125°C

53 = Max Rated Output Current

N = Negative
P = Positive

1 = 0.145”
2 = 0.210”
3 = 0.180”

00 = Open frame
BP = Baseplate

Absolute Maximum Ratings

The absolute maximum ratings below are stress ratings only. Operation at or beyond these maximum ratings can cause permanent damage to the device.

Parameter	Comments	Min	Max	Unit
Input voltage (+IN to –IN)	See Input Range Specific Characteristics for details	-0.5	75	V_{DC}
Input voltage slew rate			5	V / µs
EN to –IN		-0.5	20	V_{DC}
Output voltage (+OUT to –OUT)	See OVP setpoint max	-0.5	(see note)	V_{DC}
Output current	$P_{OUT} \leq 650W$		53	A
Dielectric withstand				
Input to output	1min	2250 1500 for IB048x		V_{DC}
Output to baseplate	1min	707		V_{DC}
Temperature				
Operating junction	Hottest semiconductor	-40	125	°C
Operating baseplate		-40	100	°C
Storage		-55	125	°C

Electrical Specifications

Specifications valid at 48V_{IN}, 100% rated load and 25°C ambient, unless otherwise indicated.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Input Range Specific Characteristics						
Part Number IB048Q120T53xx-xx						
Operating input voltage			38	48	55	V_{DC}
Non-operating input surge withstand		< 100ms			75	V_{DC}
Operating input dV / dt			0.003		5	V / µs
Undervoltage protection						
Turn–on			33		38	V_{DC}
Turn–off			31		36	V_{DC}
Turn–on / turn–off hysteresis			2			V_{DC}
Time constant					7	µs
Undervoltage blanking time		UV blanking time is enabled after start up	50	100	200	µs
Overvoltage protection						
Turn–off			60		64	V_{DC}
Turn–on			55		64	V_{DC}
Time constant					4	µs
DC output voltage band		No load, over V_{IN} range	9.5	12.0	13.8	V_{DC}
Output OVP set point		Module will shut down	15.0		16.0	V_{DC}
Dielctric withstand		Input to output and input to baseplate; 1min	1500			V_{DC}
		Output to baseplate	707			V_{DC}
Insulation resistance		Input to output		30		MΩ

Electrical Specifications (Cont.)

Specifications valid at $48V_{IN}$, 100% rated load and 25ºC ambient, unless otherwise indicated.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Input Range Specific Characteristics						
Part Number IB050Q120T53xx-xx						
Operating input voltage			36	48	60	V_{DC}
Non-operating input surge withstand		< 100ms			75	V_{DC}
Operating input dV / dt			0.003		5	V / µs
Undervoltage protection						
Turn–on			31		36	V_{DC}
Turn–off			29		34	V_{DC}
Turn–on / turn–off hysteresis			2			V_{DC}
Time constant					7	µs
Undervoltage blanking time		UV blanking time is enabled after start up	50	100	200	µs
Overvoltage protection						
Turn–off			65		69	V_{DC}
Turn–on			60		69	V_{DC}
Time constant					4	µs
DC output voltage band		No load, over V_{IN} range	9	12	15	V_{DC}
Output OVP set point		Module will shut down	16.2		17.2	V_{DC}
Dielctric withstand		Input to output and input to baseplate; 1min	2250			V_{DC}
		Output to baseplate	707			
Insulation resistance		Input to output		30		MΩ

Electrical Specifications (Cont.)

Specifications valid at $48V_{IN}$, 100% rated load and 25ºC ambient, unless otherwise indicated.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Input Range Specific Characteristics						
Part Number IB054Q120T53xx-xx						
Operating input voltage			36	48	60	V_{DC}
Non-operating input surge withstand		< 100ms			75	V_{DC}
Operating input dV / dt			0.003		5	V / µs
Undervoltage protection						
Turn–on			31		36	V_{DC}
Turn–off			29		34	V_{DC}
Turn–on / turn–off hysteresis			2			V_{DC}
Time constant					7	µs
Undervoltage blanking time		UV blanking time is enabled after start up	50	100	200	µs
Overvoltage protection						
Turn–off			76		79.5	V_{DC}
Turn–on			75		78	V_{DC}
Time constant					4	µs
DC output voltage band		No load, over V_{IN} range	9	12	15	V_{DC}
Output OVP set point		Module will shut down	19		19.8	V_{DC}
Dielctric withstand		Input to output and input to baseplate; 1min	2250			V_{DC}
		Output to baseplate	707			
Insulation resistance		Input to output		30		MΩ

Electrical Specifications (Cont.)

Specifications valid at $48V_{IN}$, 100% rated load and 25ºC ambient, unless otherwise indicated.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Common Input Specifications						
Turn ON delay						
Start-up inhibit		V_{IN} reaching turn-on voltage to enable function operational, see Figure 7	20	25	30	ms
Turn-on delay		Enable to 10% V_{OUT}; pre-applied V_{IN}, 0 load capacitance, see Figure 8			50	µs
Output voltage rise time		From 10% to 90% V_{OUT}, 10% load, 0 load capacitance, see Figure 9			50	µs
Restart turn-on delay		See page 15 for restart after EN pin disable			250	ms
No load power dissipation						
Enabled				4.0	5.5	W
Disabled				0.15	0.20	W
Input current		Low line, full load			13.5	A
Inrush current overshoot		Using test circuit in Figure 23, 15% load, high line		13	18.9	A
Input reflected ripple current		At max power; Using test circuit in Figure 24; see Figure 6			650	mArms
Peak short circuit input current					45	A
Repetitive short circuit peak current					25	A
Internal input capacitance				17.6		µF
Internal input inductance				5		nH
Recommended external input capacitance		200nH maximum source inductance	47		470	µF

Electrical Specifications (Cont.)

Specifications valid at $48V_{IN}$, 100% rated load and 25°C ambient, unless otherwise indicated.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Common Output Specifications						
Output power *			0		650	W
Output current		P ≤ 650W			53	A
Output start up load		of I_{OUT} max, maximum output capacitance			15	%
Effective output resistance				3.9		mΩ
Line regulation (K factor)		$V_{OUT} = K \bullet V_{IN}$ @ no load	0.245	0.250	0.252	
Current share accuracy		Full power operation; See Parallel Operation on page 16; up to 3 units			10	%
Efficiency						
50% load		See Figure 1	97.5	97.8		%
Full load		See Figure 1	97.0	97.3		%
Internal output inductance				1.6		nH
Internal output capacitance				75		µF
Load capacitance			0		3000	µF
Output voltage ripple		20MHz bandwidth (Figure 17), using test circuit in Figure 25		60	150	mVp-p
Output overload protection threshold		Of I_{OUT} max, will not shut down when started into max C_{OUT} and 15% load. Auto restart with duty cycle < 10%	105		150	%
Overcurrent protection time constant					1.2	ms
Short circuit current response time					1.5	µs
Switching frequency				1.0		MHz
Dynamic response – load		Load change: ±25% of I_{OUT} max, Slew rate (dI/dt) = 1A/µs See Figures 12–15				
V_{OUT} overshoot / undershoot					100	mV
V_{OUT} response time				1		µs
Dynamic response – line		Line step of 5V in 1µs, within V_{IN} operating range. (C_{IN} = 500µF, C_O = 350µF) (Figure 16 illustrates similar converter response when subjected to a more severe line transient.)				
V_{OUT} overshoot					1.25	V
Pre-bias voltage		Unit will start up into a pre-bias voltage on the output	0		15	V_{DC}

* Does not exceed IPC-9592 derating guidelines. At 70°C ambient, full power operation may exceed IPC-9592 guidelines, but does not exceed component ratings, does not activate OTP and does not compromise reliability.

Electrical Specifications (Cont.)

Specifications valid at $48V_{IN}$, 100% rated load and 25°C ambient, unless otherwise indicated.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
Control & Interface Specifications						
Enable (negative logic)		Referenced to –IN				
Module enable threshold			0.8			V_{DC}
Module enable current		V_{EN} = 0.8V		130	200	µA
Module disable threshold					2.4	V_{DC}
Modeule disable current		V_{EN} = 2.4V			10	µA
Disable hysteresis				500		mV
Enable pin open circuit voltage			2.0	2.5	3.0	V_{DC}
EN to –IN resistance		Open circuit		35		kΩ
Enable (positive logic)		Referenced to –IN				
Module enable threshold			2.0	2.5	3.0	V_{DC}
Module disable threshold					1.45	V_{DC}
EN source current (operating)		V_{EN} = 5V			2	mA
EN voltage (operating)			4.7	5	5.3	V_{DC}

General Characteristics

• Conditions: T_{CASE} = 25°C, 75% rated load and specified input voltage range unless otherwise specified.

Attribute	Symbol	Conditions / Notes	Min	Typ	Max	Unit
MTBF		Calculated per Telcordia SR-332, 40°C	1.0			Mhrs
Service life		Calculated at 30°C	7			Years
Overtemperature shut down		T_J ; Converter will reset when overtemperature condition is removed	125	130	135	°C
Mechanical						
Weight		Open frame (without baseplate)		1.38 / 39.1		oz / g
		Baseplate version		2.25 / 63.9		oz / g
Length				2.30 / 58.4		in / mm
Width				1.45 / 36.8		in / mm
Height above customer board		Open frame version		0.42 / 10.6		in / mm
		With baseplate		0.45 / 11.4		in / mm
Pin solderability		Storage life for normal solderability			1	Years
Moisture sensitivity level	MSL	Not applicable, for wave soldering only	N/A			
Clearance to customer board		From lowest component on IBC		0.12 / 3.0		in / mm
Altitude, operating		Derate operating temp 1°C per 1000 feet above sea level	-500		10000	Feet
Relative humidity, operating		Non condensing	10		90	%
RoHS compliance		Compatible with RoHS directive 2002/95/EC				
Agency approvals		UL/CSA 60950-1				cURus
		UL/CSA 60950-1, EN60950-1				cTUVus
		Low voltage directive (2006/95/EC)				CE

Electrical Specifications (Cont.)

Specifications valid at $48V_{IN}$, 100% rated load and 25°C ambient, unless otherwise indicated.

Environmental Qualification		
• IPC-9592A, based on Class II Category 2 the following detail is applicable.		
Test Description	**Test Detail**	**Min. Quanity Tested**
5.2.3 HALT (Highly Accelerated Life Testing)	Low temp	3
	High temp	3
	Rapid thermal cycling	3
	6 DOF random vibration test	3
	Input voltage test	3
	Output load test	3
	Combined stresses test	3
5.2.4 THB (Temperature Humidity Bias)	(72hr presoak required) 1000hrs – continuous bias	30
5.2.5 HTOB (High Temperature Operating Bias)	Power cycle – On 42 minutes Off 1 minute, On 1 minute, Off 1 minute, On 1 minute, Off 1 minute, On 1 minute, Off 1 minute, On 1 minute, Off 10 minutes. Alternating between maximum and minimum operating voltage every hour.	30
5.2.6 TC (Temperature Cycling)	700 cycles, 30 minute dwell at each extreme – 20C minimum ramp rate	30
5.2.7 PTC (Power & Temperature Cycling)	Reference IPC-9592A	3
5.2.8 – 5.2.13 Shock and Vibration	Random Vibration – Operating IEC 60068-2-64 (normal operation vibration)	3
	Random Vibration Non-operating (transportation) IEC 60068-2-64	3
	Shock Operating – normal operation shock IEC 60068-2-27	3
	Free fall – IEC 60068-2-32	3
	Drop Test 1 full shipping container (box)	1
5.2.14 Other Environmental Tests	5.2.14.1 Corrosion Resistance – Not required	N / A
	5.2.14.2 Dust Resistance – Unpotted class II GR-1274-CORE	3
	5.2.14.3 SMT Attachment Reliability IPC-9701 – J-STD-002	N / A
	5.2.14.4 Through Hole solderability – J-STD-002	5
ESD Classification Testing	HBM testing - JESD22-A114	3
Total Quantity (estimated)		**138**

Application Characteristics: Waveforms

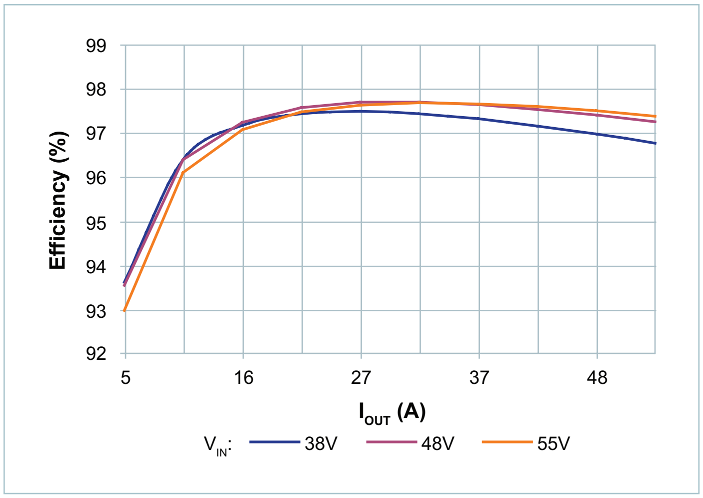


Figure 1 *— Efficiency vs. output current, 25°C ambient*

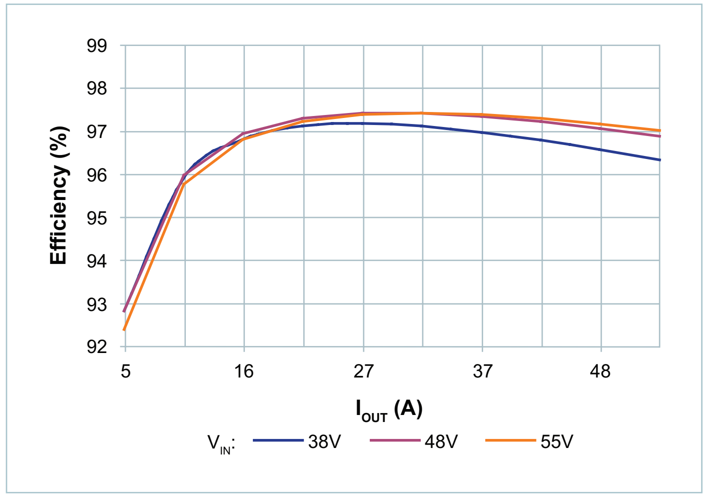


Figure 2 *— Efficiency vs. output current, 55°C ambient*

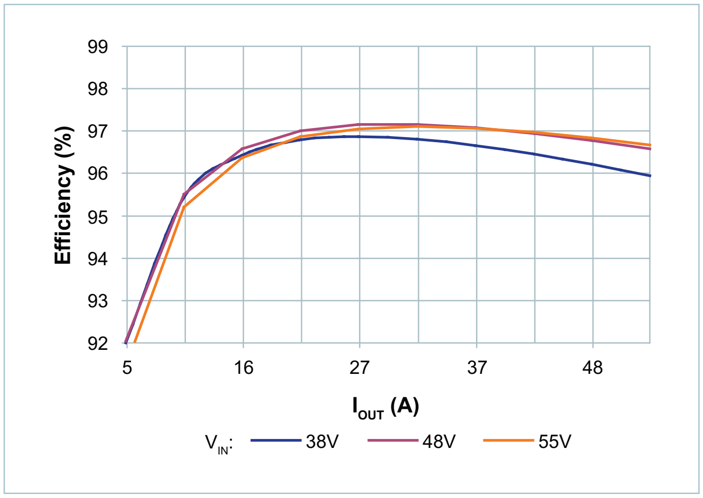


Figure 3 *— Efficiency vs. output current, 70°C ambient*

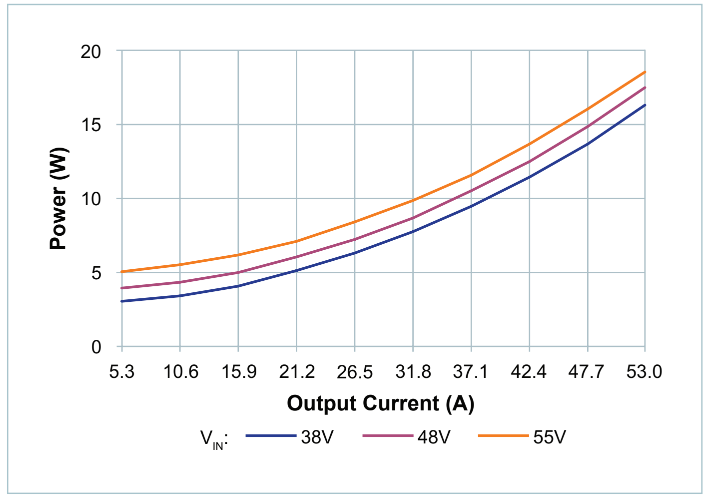


Figure 4 *— Power dissipation vs. output current at V_{IN}, 25°C ambient*

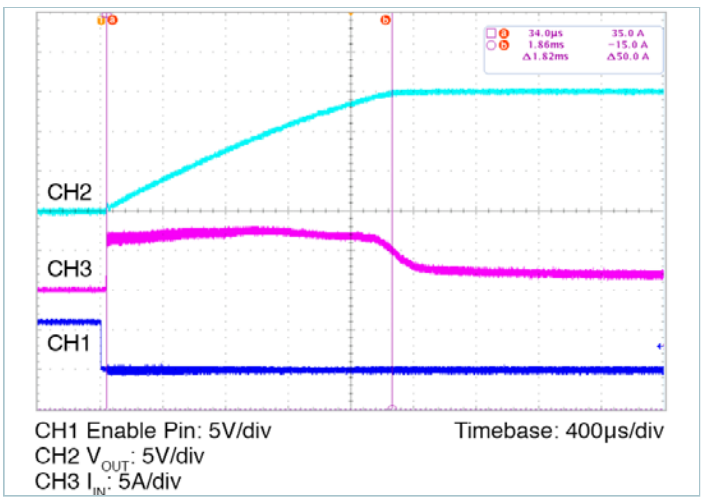


Figure 5 *— Inrush current at high line 15% load; 5A/div, max load capacitance*

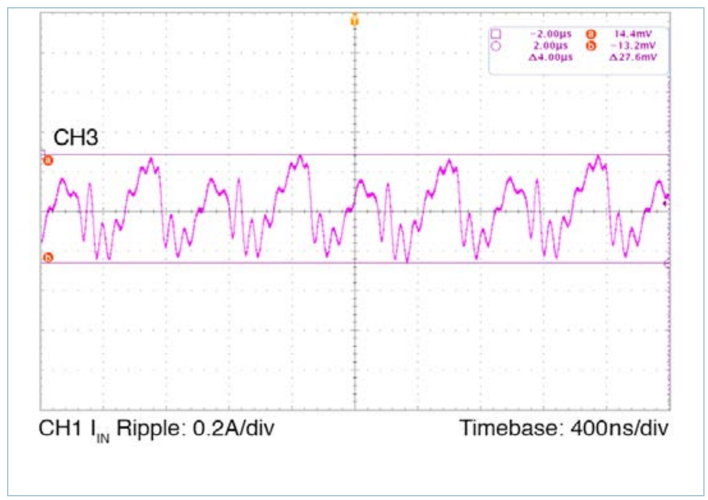


Figure 6 *— Input reflected ripple current at nominal line, full load See Figure 24 for setup*

Application Characteristics: Waveforms (Cont.)

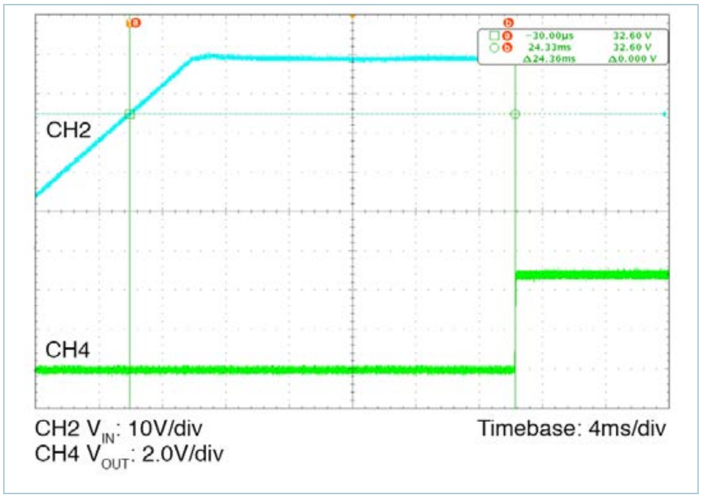


Figure 7 *— Turn on delay time; V_{IN} turn on delay at nominal line, 15% load*

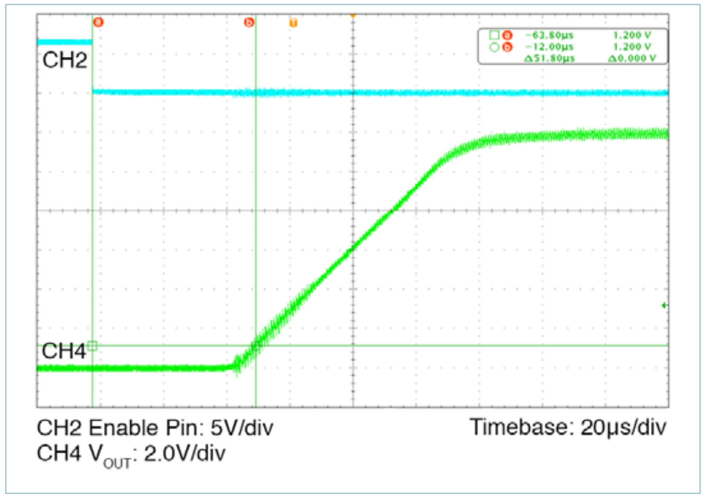


Figure 8 *— Turn on delay time; enable at nominal line, 15% load, 0 capacitance.*

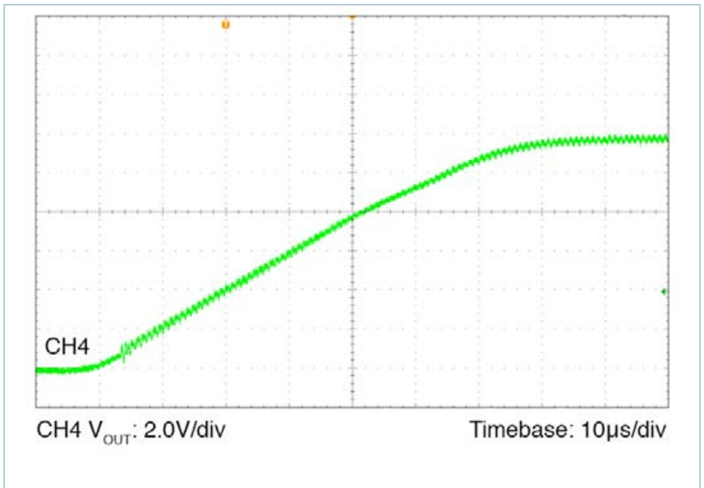


Figure 9 *— Output voltage rise time at nominal line, 10% load, 0 capacitance*

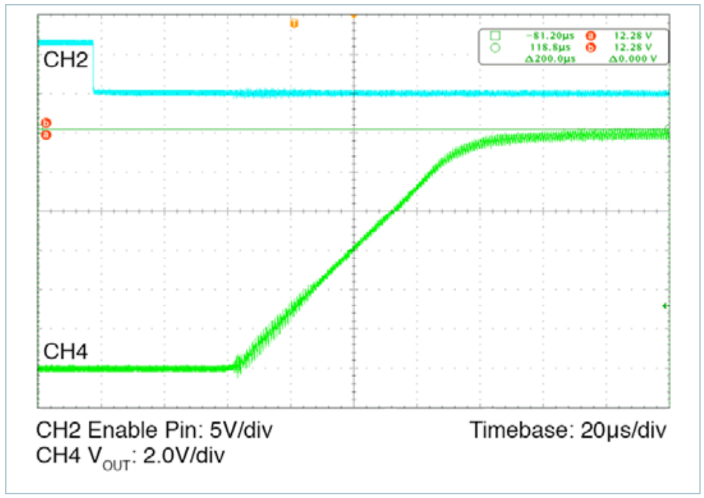


Figure 10 *— Overshoot at turn on at nominal line, 15% load, 0 capacitance*

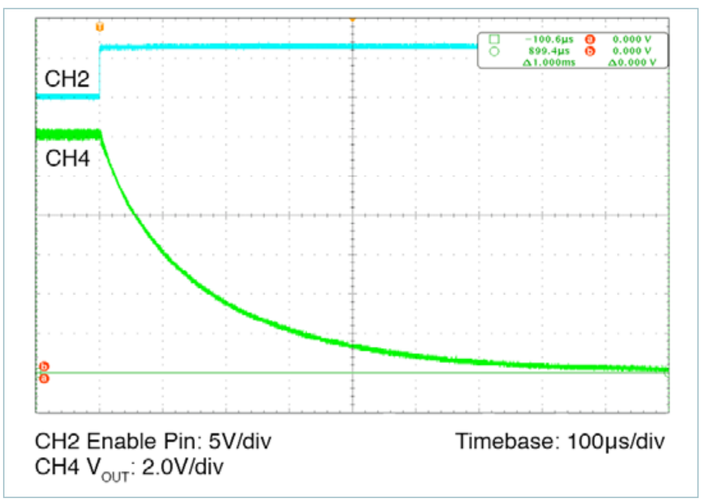


Figure 11 *— Undershoot at turn off at nominal line; 15% load, 0 load capacitance*

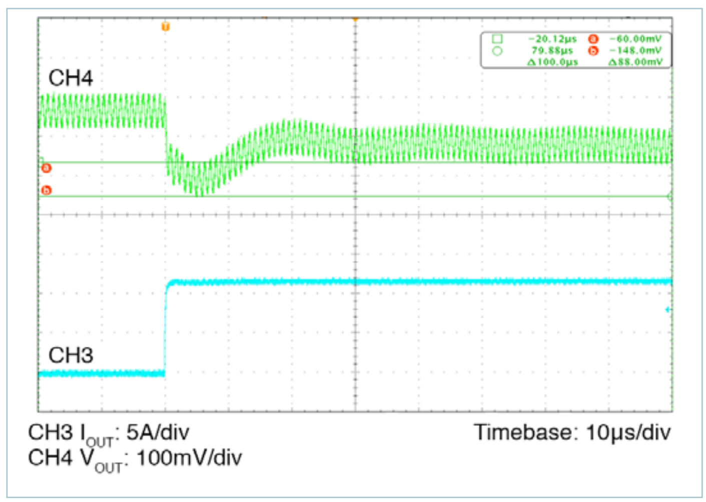


Figure 12 *— Load transient response; nominal line, load step 75–100%*

Application Characteristics: Waveforms (Cont.)

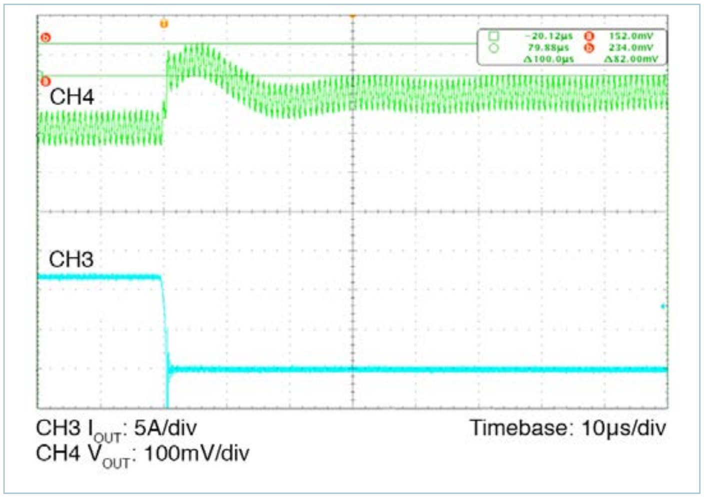


Figure 13 *— Load transient response; full load to 75%; nominal line*

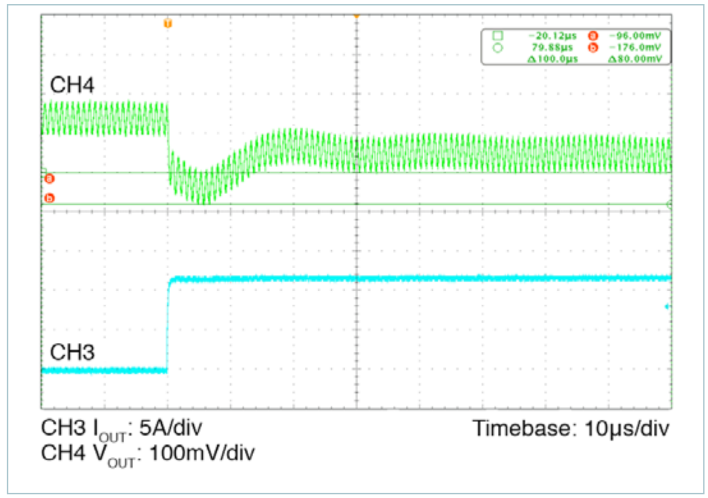


Figure 14 *— Load transient response, nominal line Load step 0–25%*

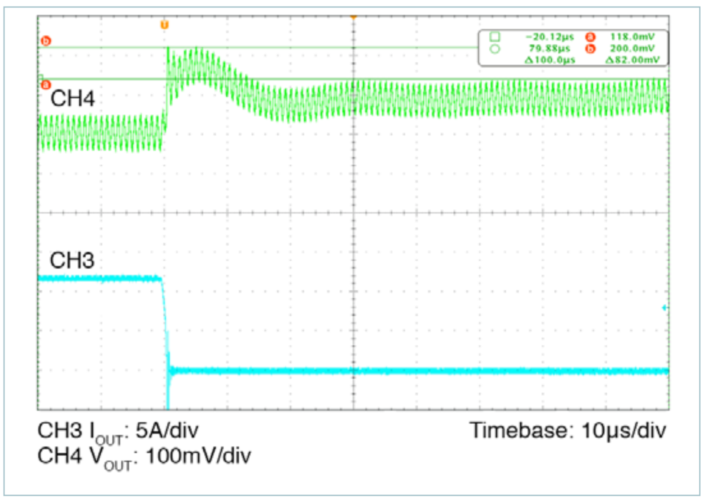


Figure 15 *— Load transient response; nominal line Load step 25–0%*

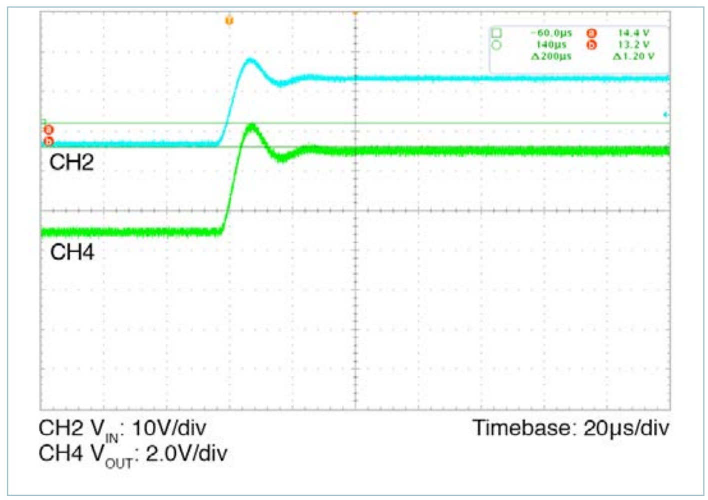


Figure 16 *— Input transient response; V_{IN} step low line to high line at full load*

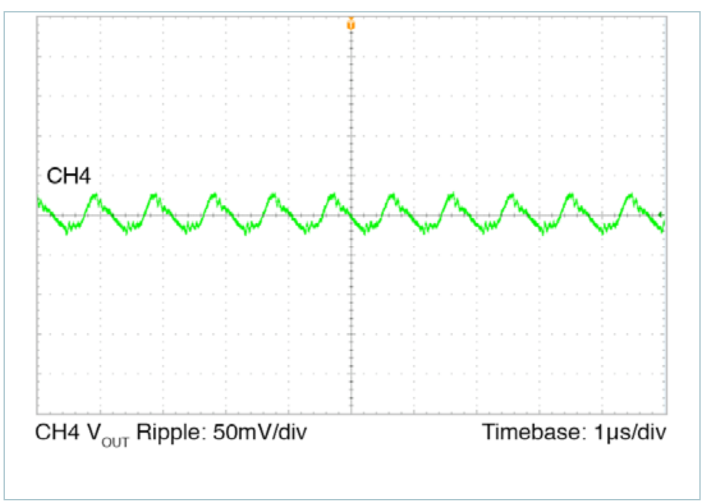


Figure 17 *— Output ripple; nominal line, full load*

Application Characteristics: Waveforms (Cont.)

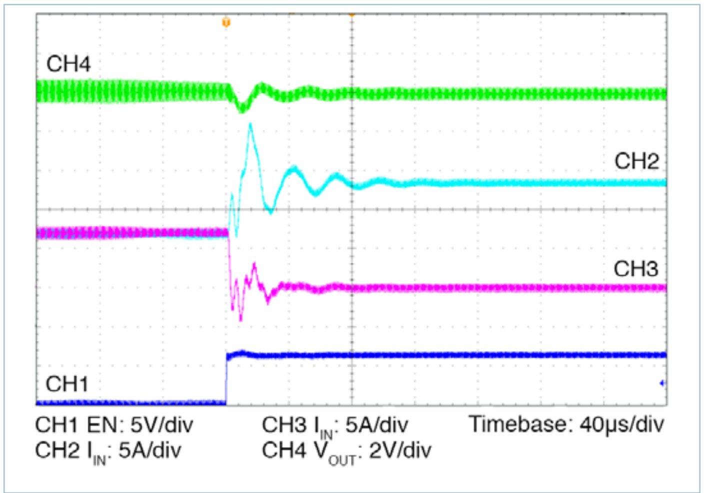


Figure 18 — *Two modules parallel array test. V_{OUT} and I_{IN} change when one module is disabled. Nominal V_{IN}, I_{OUT} = 53A*

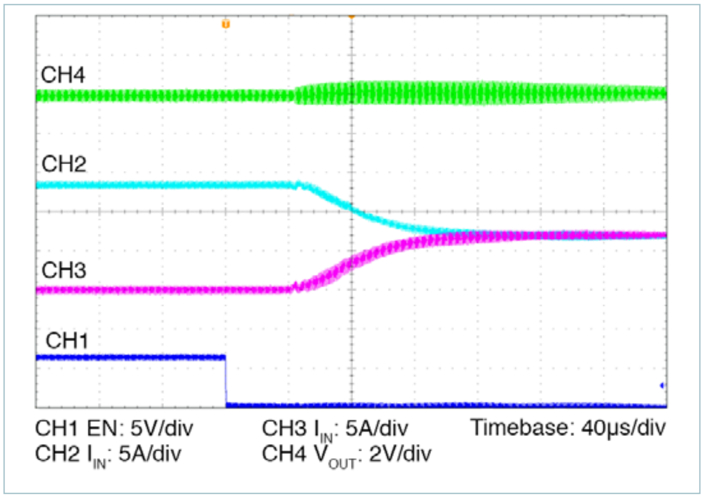


Figure 19 — *Two modules parallel array test. V_{OUT} and I_{IN} change when one module is enabled. Nominal V_{IN}, I_{OUT} = 53A*

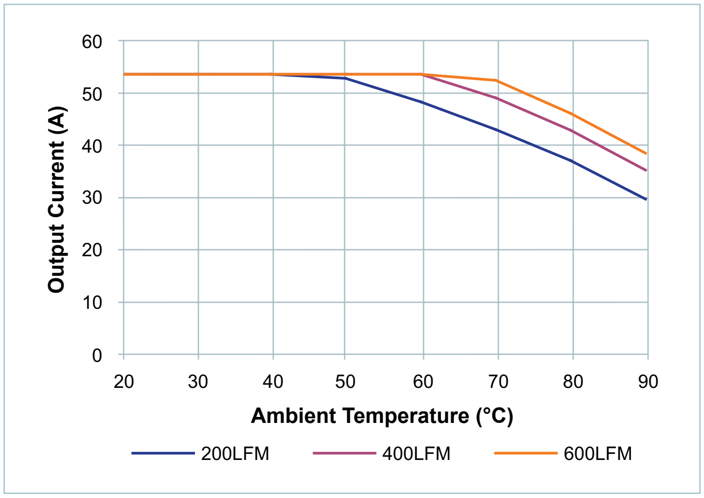


Figure 20 — *Maximum output current derating vs. ambient air temperature. Transverse airflow. Board and junction temperatures within IPC-9592 derating guidelines*

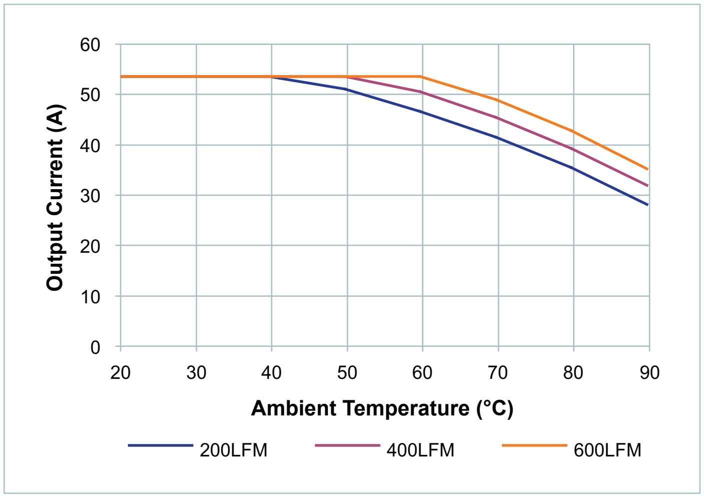


Figure 21 — *Maximum output current derating vs. ambient air temperature. Longitudinal airflow. Board and junction temperatures within IPC-9592 derating guidelines*

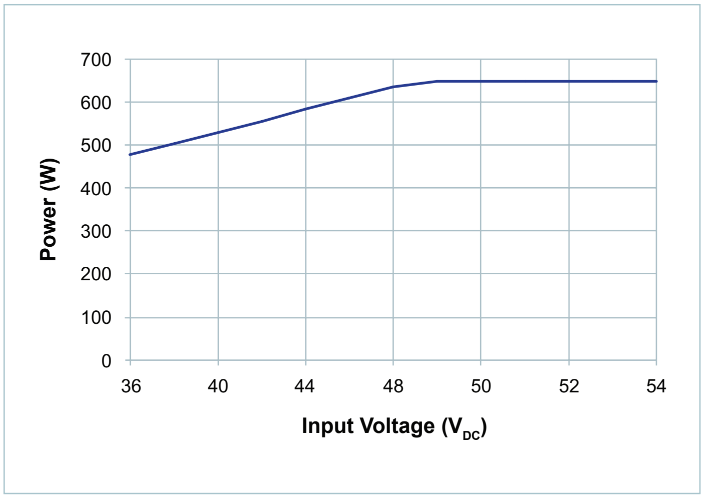


Figure 22 — *Maximum output ower vs. input voltage*

Application Characteristics: Waveforms (Cont.)

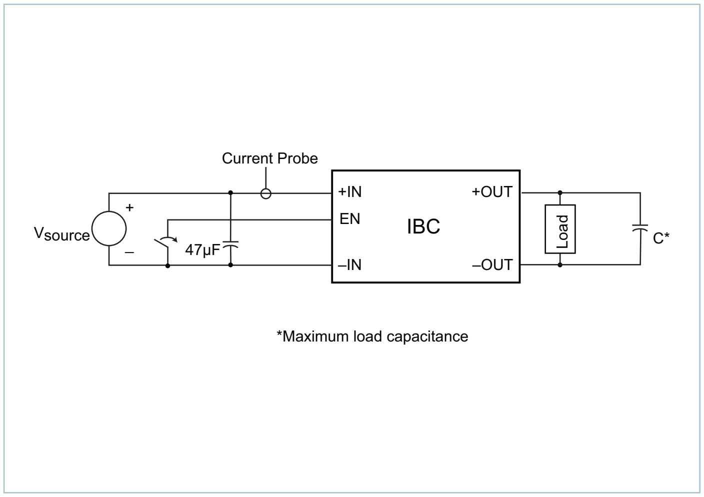


Figure 23 — *Test circuit; inrush current overshoot*

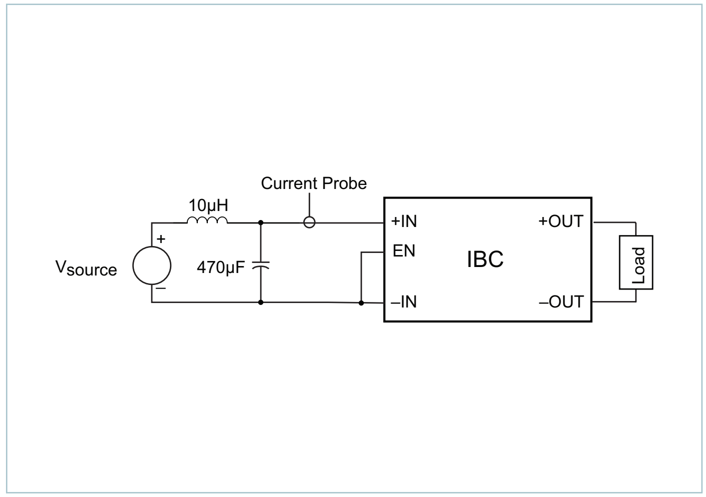


Figure 24 — *Test circuit; input reflected ripple current*

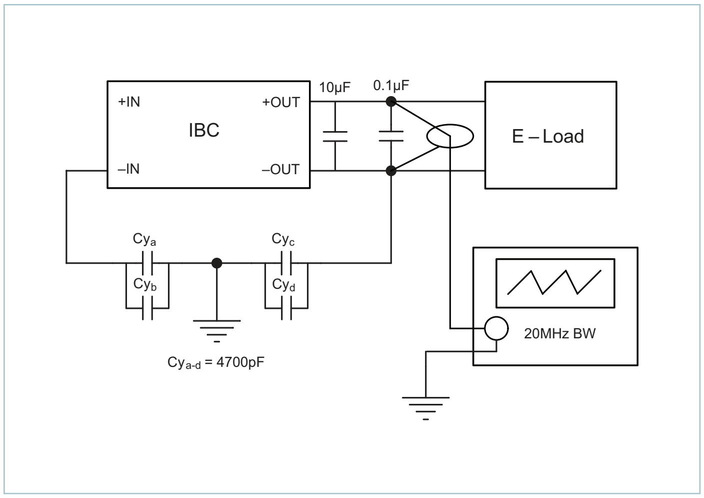


Figure 25 — *Test circuit; output voltage ripple*

Application Characteristics: Thermal Data

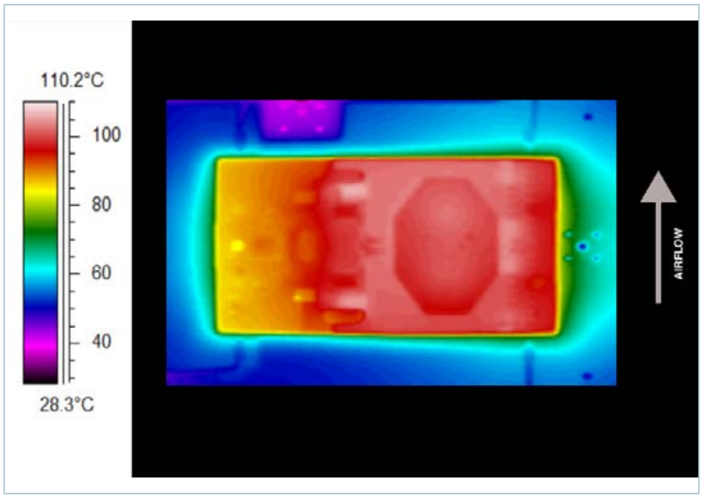


Figure 26 *— Thermal plot, 200LFM, 25°C, 48V_{IN}, 600W output power*

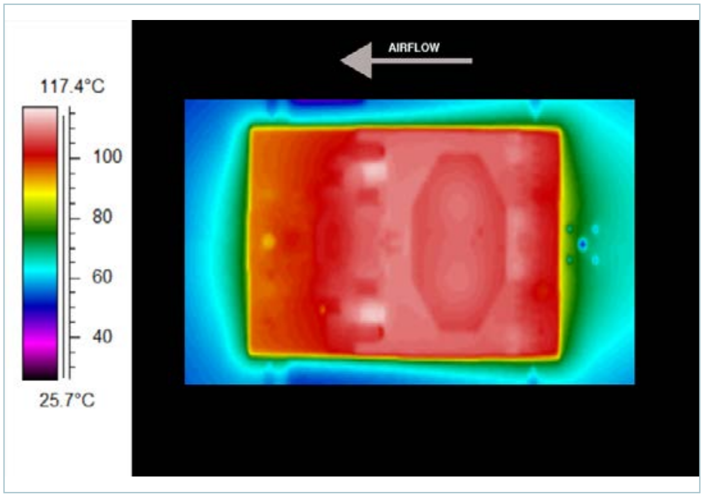


Figure 27 *— Thermal plot, 200LFM, 25°C, 48V_{IN}, 600W output power*

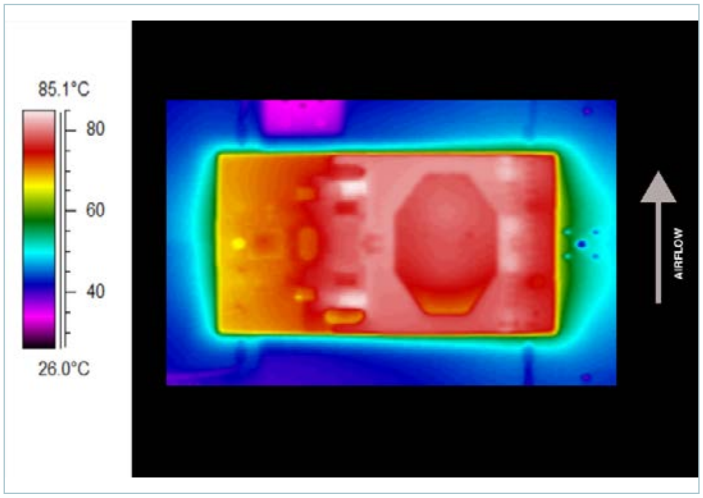


Figure 28 *— Thermal plot, 400LFM, 25°C, 48V_{IN}, 600W output power*

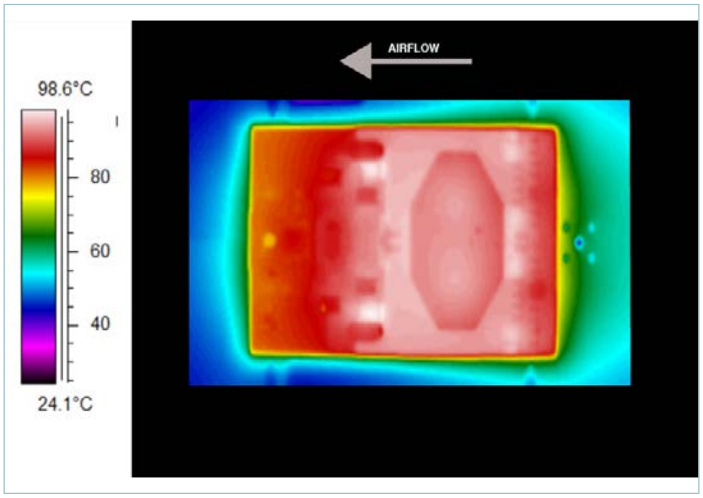


Figure 29 *— Thermal plot, 400LFM, 25°C, 48V_{IN}, 600W output power*

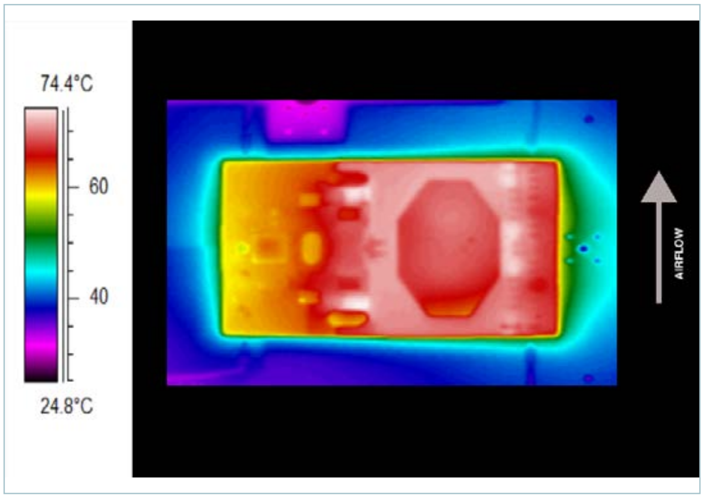


Figure 30 *— Thermal plot, 600LFM, 25°C, 48V_{IN}, 600W output power*

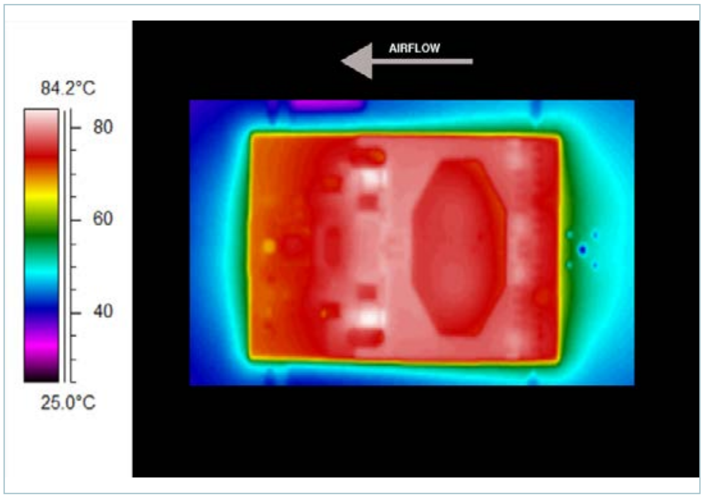


Figure 31 *— Thermal plot, 600LFM, 25°C, 48V_{IN}, 600W output power*

Pin / Control Functions

+IN / –IN — DC Voltage Input Pins

The IBC input voltage range should not be exceeded. An internal undervoltage/overvoltage lockout function prevents operation outside of the normal operating input range. The IBC turns on within an input voltage window bounded by the "Input undervoltage turn-on" and "Input overvoltage turn-off" levels, as specified. The IBC may be protected against accidental application of a reverse input voltage by the addition of a rectifier in series with the positive input, or a reverse rectifier in shunt with the positive input located on the load side of the input fuse.

The connection of the IBC to its power source should be implemented with minimal distribution inductance. If the interconnect inductance exceeds 100nH, the input should be bypassed with a RC damper to retain low source impedance and stable operation. With an interconnect inductance of 200nH, the RC damper may be 47µF in series with 0.3Ω. A single electrolytic or equivalent low-Q capacitor may be used in place of the series RC bypass.

EN — Enable/Disable

Negative logic option

If the EN port is left floating, the IBC output is disabled. Once this port is pulled lower than $0.8V_{DC}$ with respect to –IN, the output is enabled. The EN port can be driven by a relay, optocoupler, or open collector transistor. Refer to Figure 8 for the typical enable / disable characteristics. This port should not be toggled at a rate higher than 1Hz. The EN port should also not be driven by or pulled up to an external voltage source.

Positive logic option

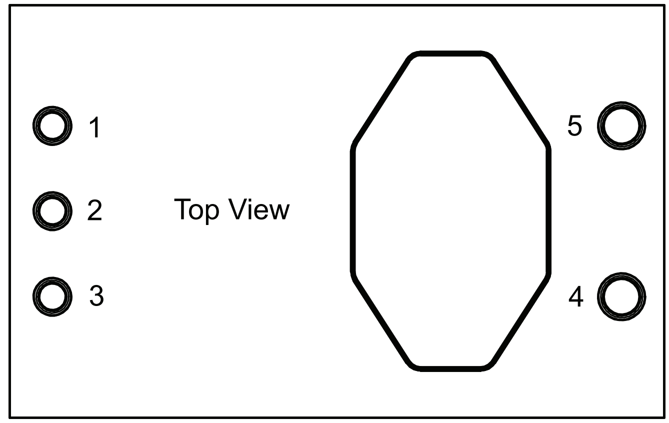
If the EN port is left floating, the IBC output is enabled. Once this port is pulled lower than $1.4V_{DC}$ with respect to –IN, the output is disabled. This action can be realized by employing a relay, optocoupler, or open collector transistor. This port should not be toggled at a rate higher than 1Hz.

The EN port should also not be driven by or pulled up to an external voltage source. The EN port can source up to 2mA at $5V_{DC}$. The EN port should never be used to sink current.

If the IBC is disabled using the EN pin, the module will attempt to restart approximately every 250ms. Once the module has been disabled for at least 250ms, the turn on delay after the EN pin is enabled will be as shown in Figure 8.

+OUT / –OUT — DC Voltage Output Pins

Total load capacitance at the output of the IBC should not exceed the specified maximum. Owing to the wide bandwidth and low output impedance of the IBC, low frequency bypass capacitance and significant energy storage may be more densely and efficiently provided by adding capacitance at the input of the IBC.



Pin Number	Function
1	V_{IN+}
2	Enable
3	V_{IN-}
4	V_{OUT-}
5	V_{OUT+}

Figure 32 — *IBC Pin Designations*

Applications Note

Parallel Operation

The IBC will inherently current share when operated in an array. Arrays may be used for higher power or redundancy in an application. Current sharing accuracy is maximized when the source and load impedance presented to each IBC within an array are equal. The recommended method to achieve matched impedances is to dedicate common copper planes within the PCB to deliver and return the current to the array, rather than rely upon traces of varying lengths. In typical applications the current being delivered to the load is larger than that sourced from the input, allowing narrower traces to be utilized on the input side if necessary. The use of dedicated power planes is, however, preferable.

One or more IBCs in an array may be disabled without adversely affecting operation or reliability as long as the load does not exceed the rated power of the enabled IBCs.

The IBC power train and control architecture allow bi-directional power transfer, including reverse power processing from the IBC output to its input. The IBC's ability to process power in reverse improves the IBC transient response to an output load dump.

Thermal Considerations

The temperature distribution of the VI Brick® can vary significantly with its input / output operating conditions, thermal management and environmental conditions. Although the PCB is UL rated to 130°C, it is recommended that PCB temperatures be maintained at or below 125°C. For maximum long term reliability, lower PCB temperatures are recommended for continuous operation, however, short periods of operation at 125°C will not negatively impact performance or reliability.

WARNING: Thermal and voltage hazards. The IBC can operate with surface temperatures and operating voltages that may be hazardous to personnel. Ensure that adequate protection is in place to avoid inadvertent contact.

Input Impedance Recommendations

To take full advantage of the IBC capabilities, the impedance presented to its input terminals must be low from DC to approximately 5MHz. The source should exhibit low inductance and should have a critically damped response. If the interconnect inductance is excessive, the IBC input pins should be bypassed with an RC damper (e.g., 47µF in series with 0.3Ω) to retain low source impedance and proper operation. Given the wide bandwidth of the IBC, the source response is generally the limiting factor in the overall system response.

Anomalies in the response of the source will appear at the output of the IBC multiplied by its K factor. The DC resistance of the source should be kept as low as possible to minimize voltage deviations. This is especially important if the IBC is operated near low or high line as the overvoltage/undervoltage detection circuitry could be activated.

Input Fuse Recommendations

The IBC is not internally fused in order to provide flexibility in configuring power systems. However, input line fusing of VI Bricks must always be incorporated within the power system. A fast acting fuse should be placed in series with the +IN port. See safety agency approvals.

Application Notes

For IBC and VI Brick application notes on soldering, thermal management, board layout, and system design visit www.vicorpower.com.

Mechanical Drawings

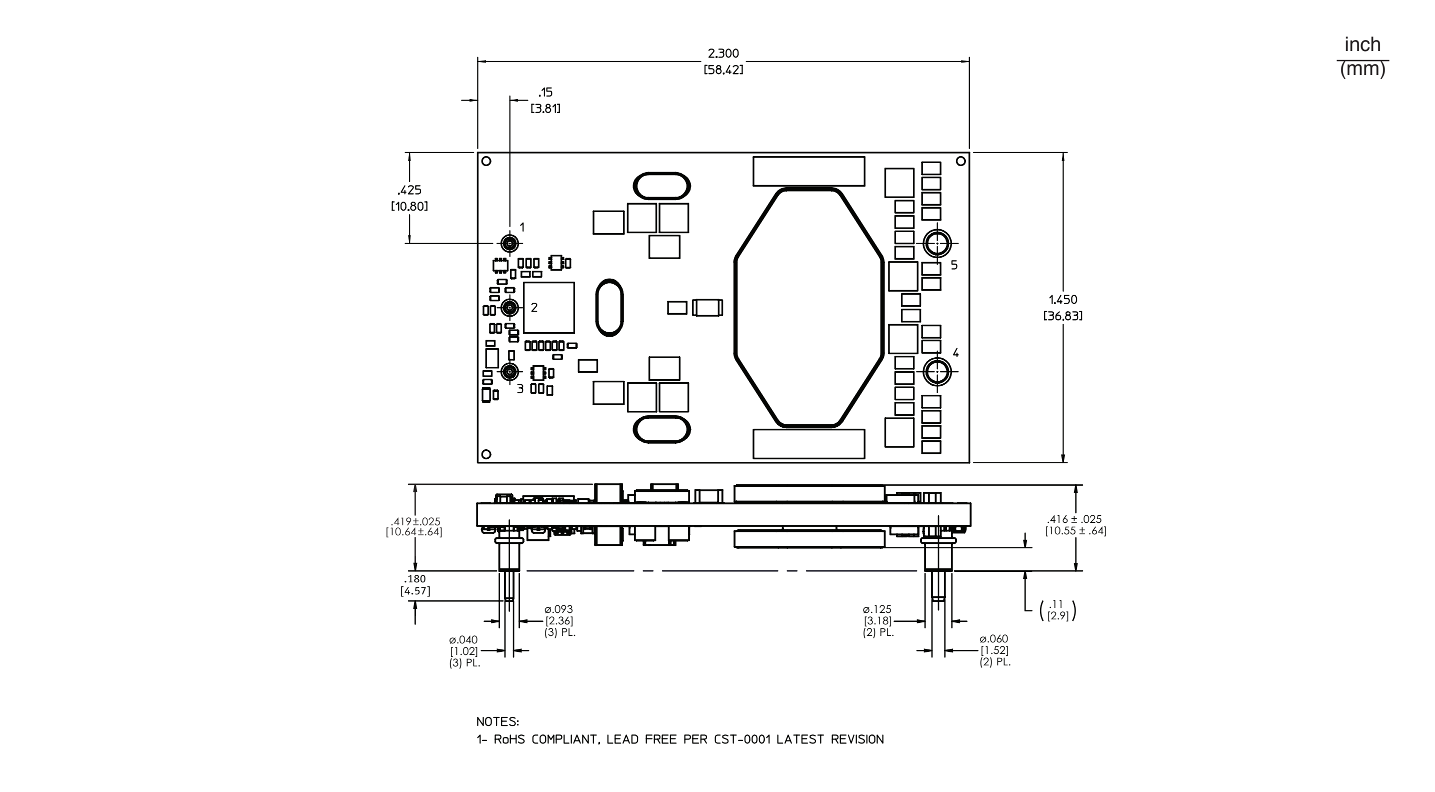


Figure 33 *— IBC outline drawing*

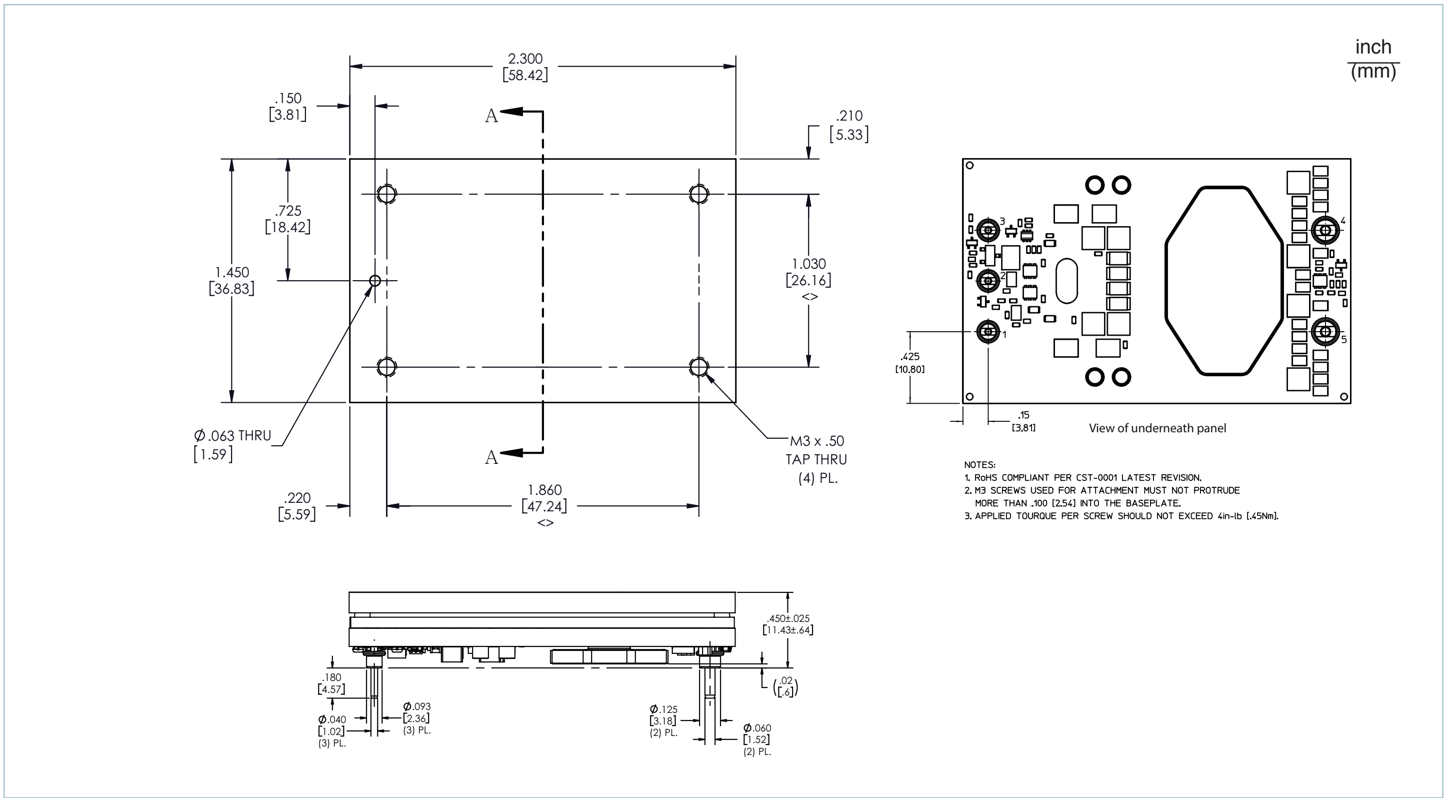


Figure 34 *— IBC outline drawing – baseplate option*

Mechanical Drawings (Cont.)

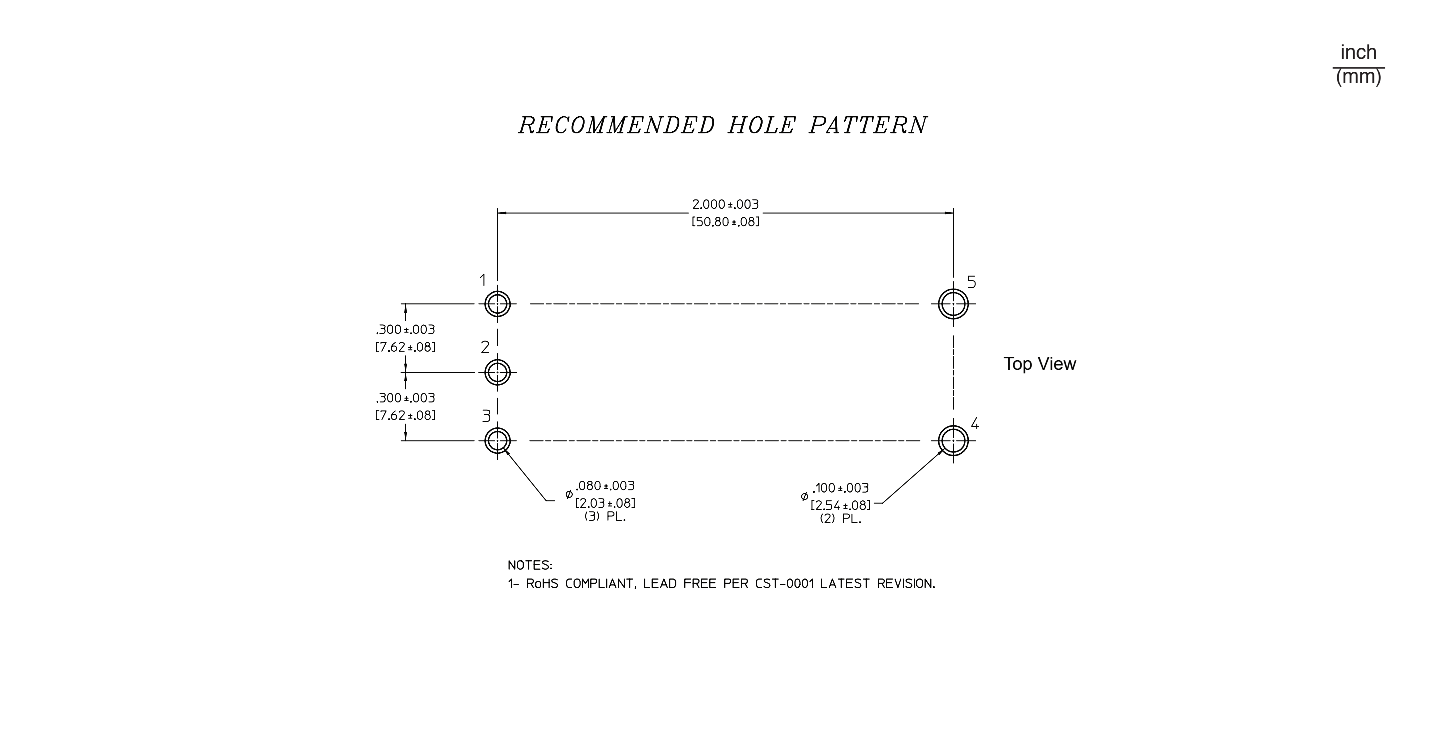


Figure 35 *— IBC PCB recommended hole pattern*

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